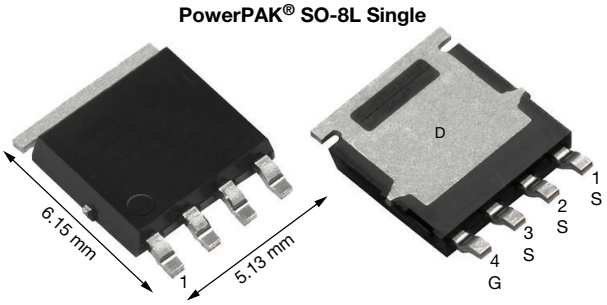
N-Channel 100 V (D-S) MOSFET

PowerPAK® SO-8L Single



Top View Bottom View

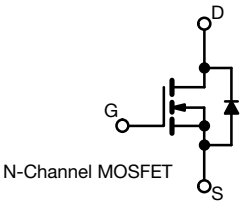
FEATURES

- TrenchFET® Gen IV power MOSFET
- Very low Q_g and Q_{oss} reduce power loss and improve efficiency
- Flexible leads provide resilience to mechanical stress
- 100 % R_g and UIS tested
- Q_{gd}/Q_{gs} ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- DC/AC inverters
- Boost converter
- LED backlighting



N-Channel MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	100
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.009
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0106
Q_g typ. (nC)	26.5
I_D (A) [a]	56.7
Configuration	Single

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiJ4108DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	100	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_D	56.7	A
	T_C = 70 °C		45.3	
	T_A = 25 °C		15.2 [b, c]	
	T_A = 70 °C		12.1 [b, c]	
Pulsed drain current (t = 100 µs)		I_{DM}	150	
Continuous source-drain diode current	T_C = 25 °C	I_S	63.1	
	T_A = 25 °C		4.5 [b, c]	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	25	
Single pulse avalanche energy		E_{AS}	31.25	mJ
Maximum power dissipation	T_C = 25 °C	P_D	69.4	W
	T_C = 70 °C		44	
	T_A = 25 °C		5 [b, c]	
	T_A = 70 °C		3.2 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) [d, e]			260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient [b, f]	t ≤ 10 s	R_{thJA}	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.3	1.8	

Notes

a. T_C = 25 °C
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
f. Maximum under steady state conditions is 65 °C/W

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 1 mA	100	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = 1 mA	-	63	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA	-	-7.3	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	2	-	4	V
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{DS} = 100 V, V_{GS} = 0 V	-	-	1	µA
		V_{DS} = 100 V, V_{GS} = 0 V, T_J = 75 °C	-	-	15	
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 15 A	-	0.0075	0.009	Ω
		V_{GS} = 7.5 V, I_D = 10 A	-	0.0085	0.0106	
Forward transconductance [a]	g_{fs}	V_{DS} = 15 V, I_D = 15 A	-	70	-	S
Dynamic [b]						
Input capacitance	C_{iss}	V_{DS} = 50 V, V_{GS} = 0 V, f = 1 MHz	-	2440	-	pF
Output capacitance	C_{oss}		-	255	-	
Reverse transfer capacitance	C_{rss}		-	16.2	-	
Total gate charge	Q_g	V_{DS} = 50 V, V_{GS} = 10 V, I_D = 15 A	-	34.5	52	nC
		V_{DS} = 50 V, V_{GS} = 7.5 V, I_D = 15 A	-	26.5	40	
Gate-source charge	Q_{gs}		-	12	-	
Gate-drain charge	Q_{gd}		-	5.3	-	
Output charge	Q_{oss}	V_{DS} = 50 V, V_{GS} = 0 V	-	46	-	
Gate resistance	R_g	f = 1 MHz	0.3	0.8	1.4	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = 50 V, R_L = 3.33 Ω $I_D \cong$ 15 A, V_{GEN} = 10 V, R_g = 1 Ω	-	15	30	ns
Rise time	t_r		-	7	14	
Turn-off delay time	$t_{d(off)}$		-	25	50	
Fall time	t_f		-	6	12	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 50 V, R_L = 3.33 Ω $I_D \cong$ 15 A, V_{GEN} = 7.5 V, R_g = 1 Ω	-	18	36	
Rise time	t_r		-	8	16	
Turn-off delay time	$t_{d(off)}$		-	22	44	
Fall time	t_f		-	7	14	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	T_C = 25 °C	-	-	63.1	A
Pulse diode forward current (t_p = 100 µs)	I_{SM}		-	-	150	
Body diode voltage	V_{SD}	I_S = 5 A	-	0.75	1.1	V
Body diode reverse recovery time	t_{rr}	I_F = 10 A, di/dt = 100 A/µs, T_J = 25 °C	-	42	84	ns
Body diode reverse recovery charge	Q_{rr}		-	55	110	nC
Reverse recovery fall time	t_a		-	26	-	ns
Reverse recovery rise time	t_b		-	16	-	

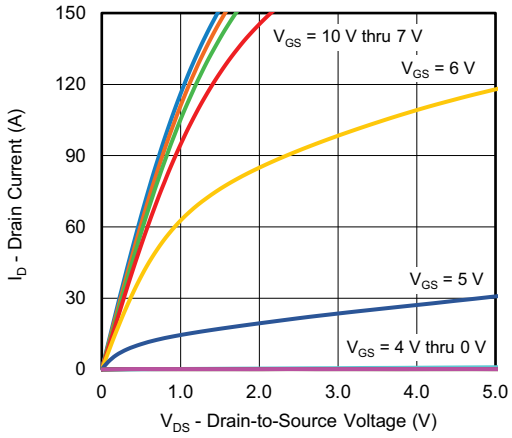
Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %

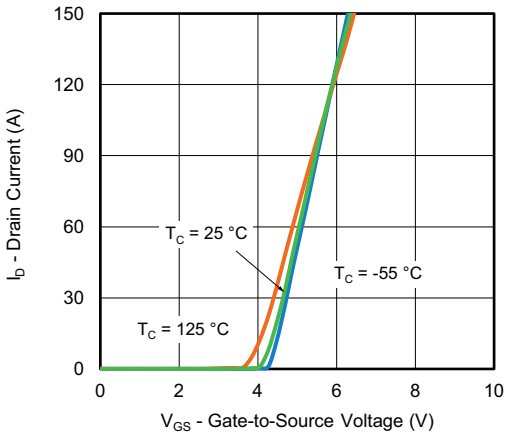
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

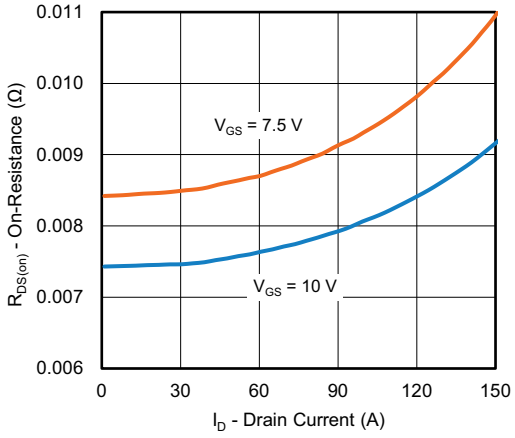
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



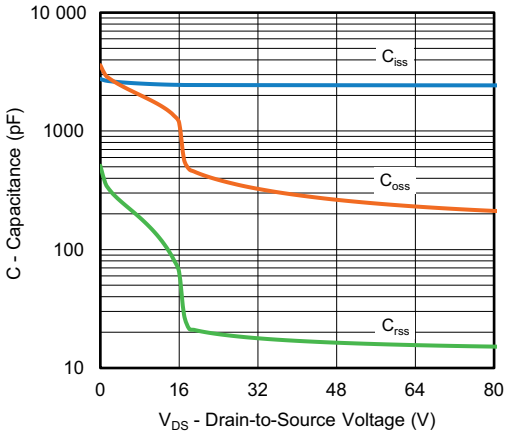
Output Characteristics



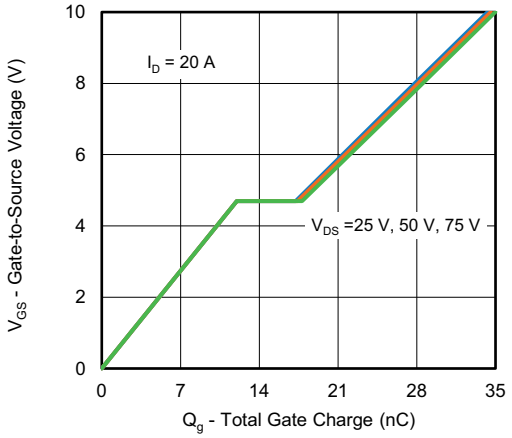
Transfer Characteristics



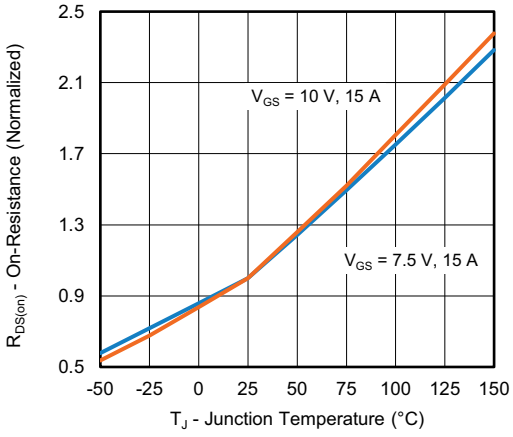
On-Resistance vs. Drain Current



Capacitance

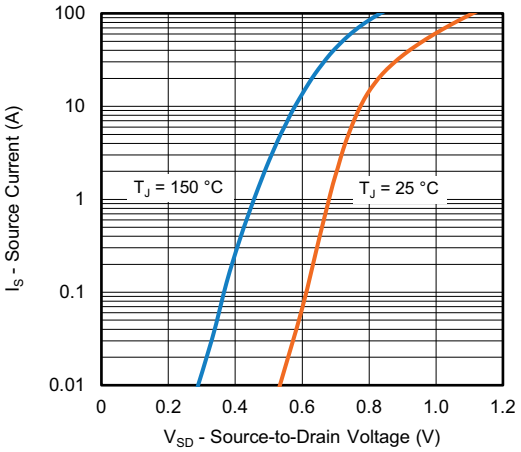


Gate Charge

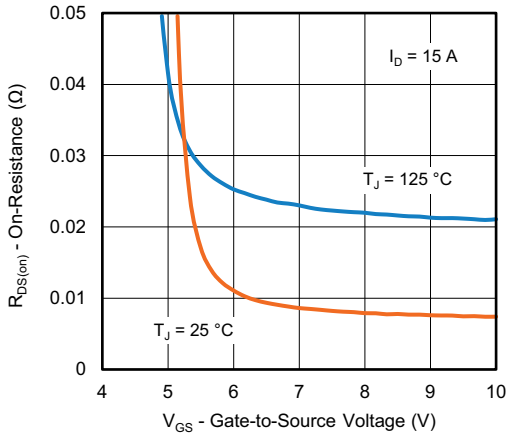


On-Resistance vs. Junction Temperature

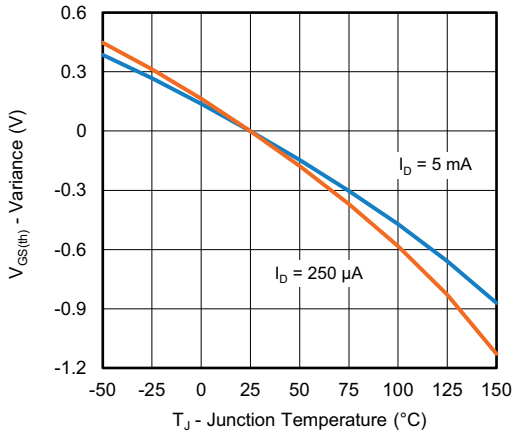
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



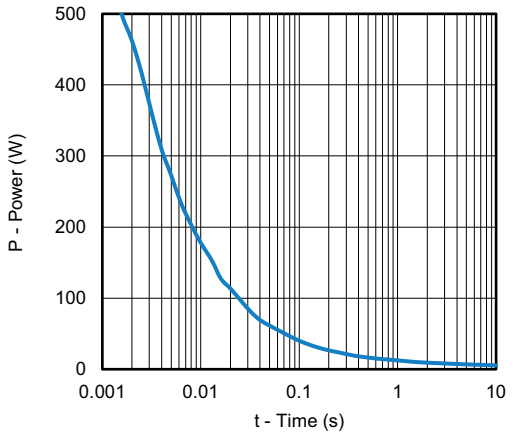
Source-Drain Diode Forward Voltage



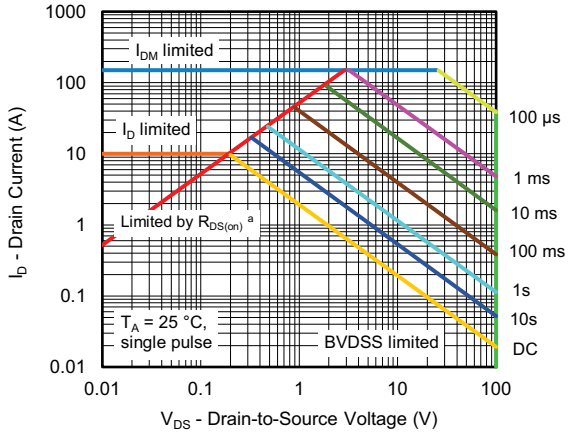
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

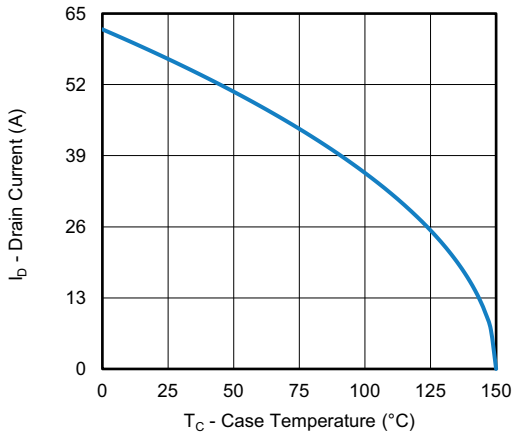


Safe Operating Area

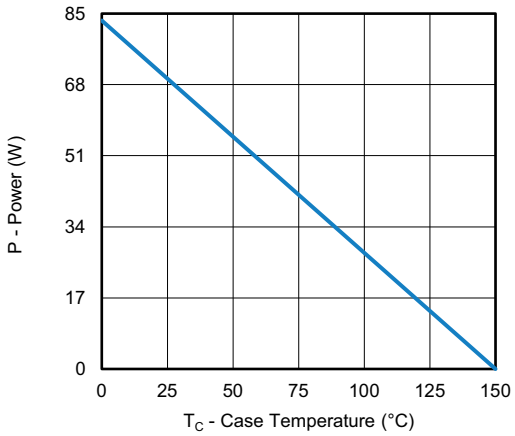
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

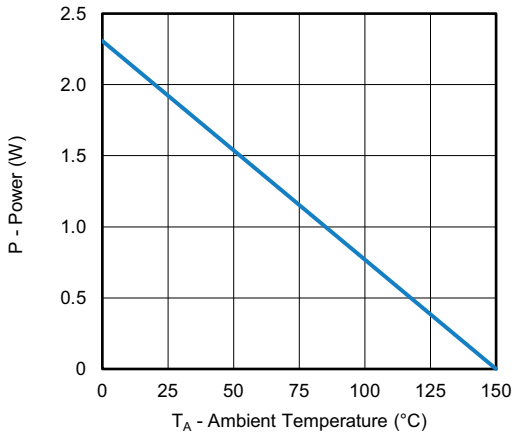
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating [a]



Power, Junction-to-Case

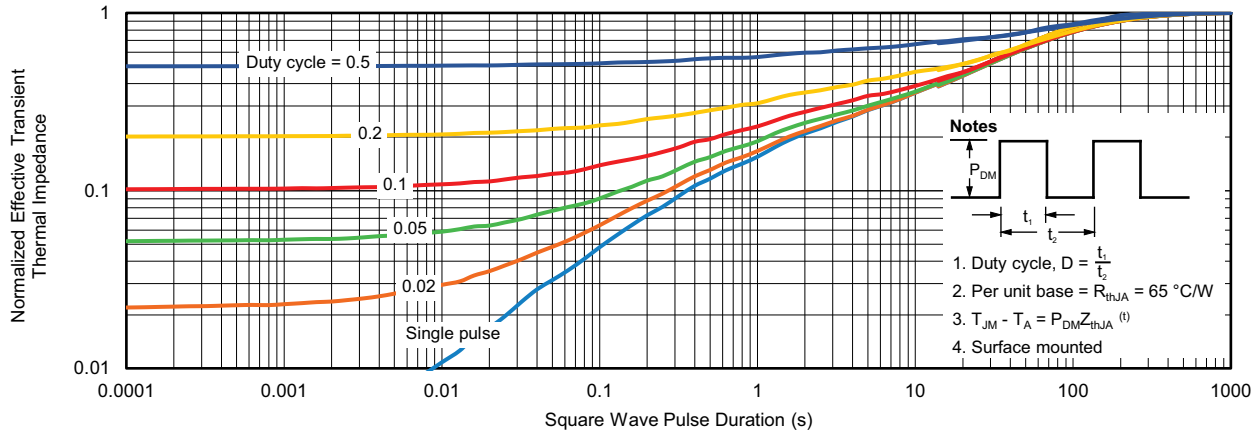


Power, Junction-to-Ambient

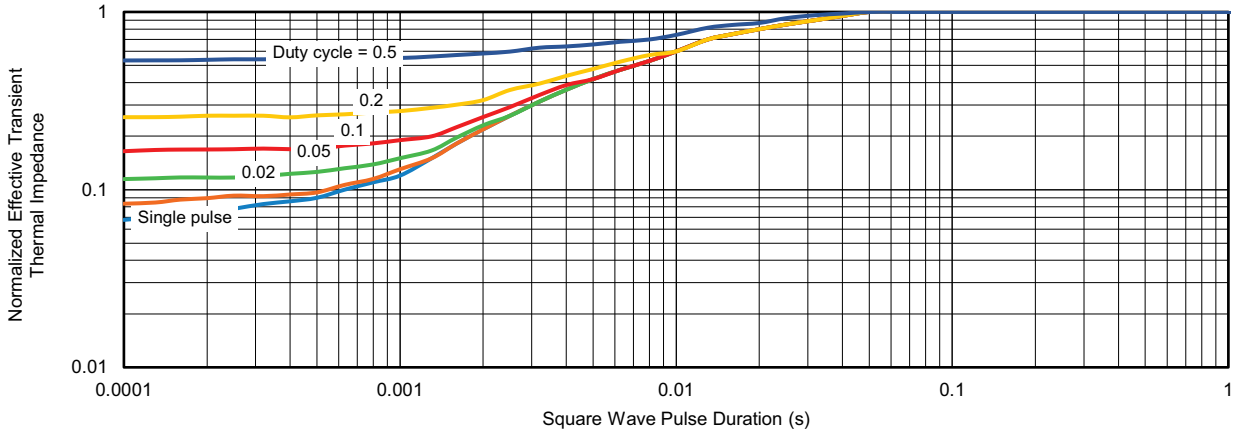
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62153.

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, “Vishay”), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Vishay ***manufacturer:***

Other Similar products are found below :

VS-30CTQ045-1PBF DG211BDY VLMK23R1S1-GS08 VJ1206V106MXQTW1BC VLMS2100-GS08 LL43-GS08 BAS86-GS08 BAS385-TR CRCW040210R0FKTD CRCW040215R0FKEDHP CRCW0603120KFKEA CRCW060333R2FKTA CRCW06034K12FKEA CRCW0805110KFKEA CRCW12063K30FKEAHP M39006/25-0228 M55342K12B100ERWB M64W103KB40 M64Z501KB40 CW0055R000JE12 CW010330R0JE12HE MAL202117102E3 MAL202118471E3 MAL202190518E3 715C30DKD47 MBA02040C3328FRP00 MBA02040C5109FC100 MBB02070C4700FC100 MCT06030C2709FP500 MDP1603470RGE04 FESB8JT-E3/81 MKT1813410405 MKT1813422014 MMA21-0341K1-101 MMB02070C5609FB200 PE60L0FGW471MA PHP01206E2002BST5 PR02000203608JR500 PR02000209102JR500 RCL040647R0JNEA RCWE1210R360FKEA RCWE1210R560FKEA RE65G5R60C02 RH005220R0FE02 RH010600R0FC02 135D255X9100C6 135D566X9030C6 135D866X0100K2 135D106X0100C2 RL07S910GB14